

ON Semiconductor®

FDBL86561-F085

N-Channel PowerTrench[®] MOSFET

60 V, 300 A, 1.1 mΩ

Features

- Typical $R_{DS(on)}$ = 0.85 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical $Q_{g(tot)}$ = 170 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		60	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
ID	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	300		
	Pulsed Drain Current	T _C = 25°C	See Figure 4	— A	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	1167	mJ	
D	Power Dissipation		429	W	
PD	Derate Above 25°C		2.86	W/ ^o C	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.35	°C/W	
R _{0JA}	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W	

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Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting T_J = 25°C, L = 0.57mH, I_{AS} = 64A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche. 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder
- 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

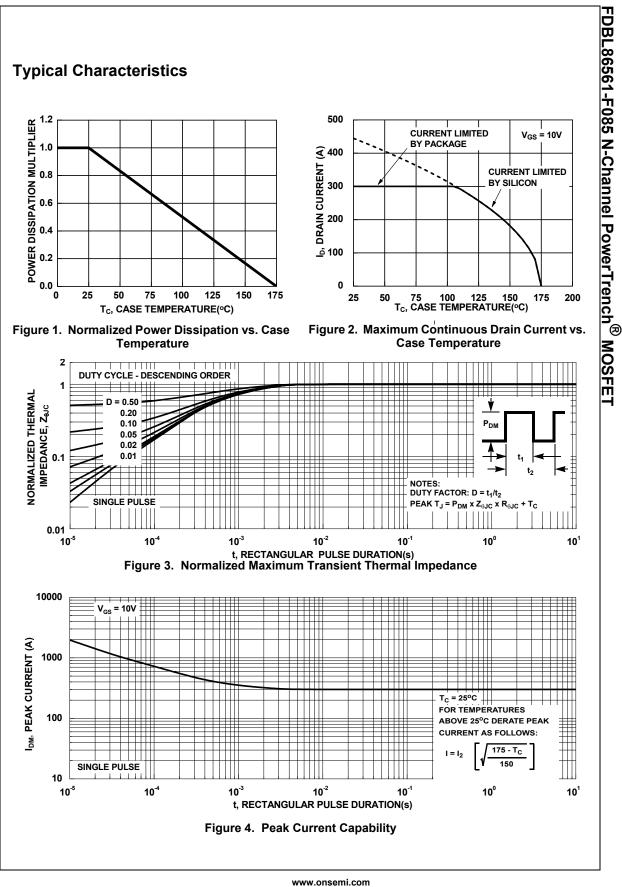
Package Marking and Ordering Information

Device Marking	Device	Package			
FDBL86561	FDBL86561-F085	MO-299A	-	-	-

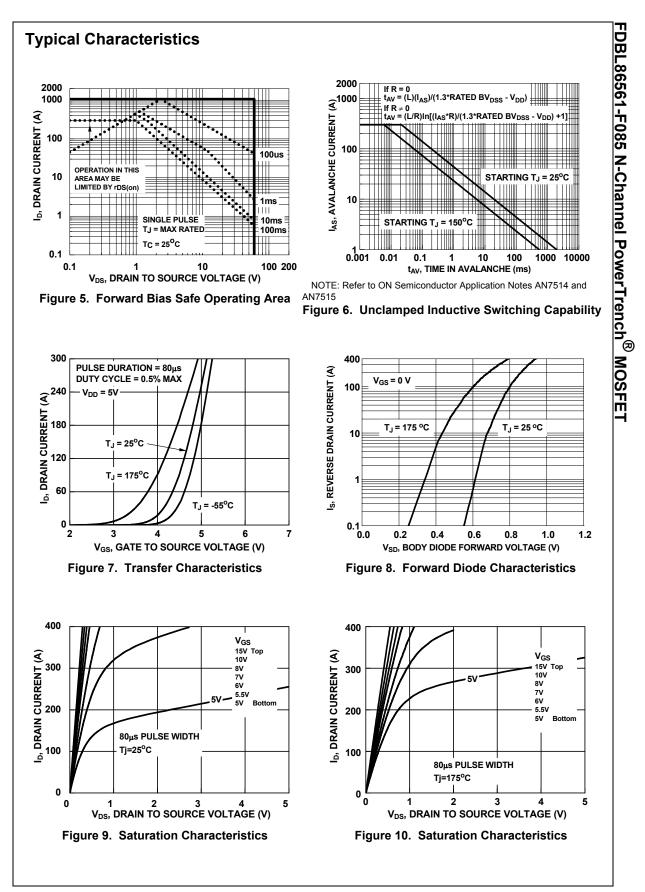


	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics		I				
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA,	V _{GS} =0V	60	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 60V	$T_J = 25^{\circ}C$	-	-	1	μA
			T _J = 175 ^o C (Note 4)	-	-	3	mA
I _{GSS}	Gate-to-Source Leakage Current	V_{GS} = ±20V		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$,	l _D = 250μA	2.0	3.0	4.0	V
Read N	Drain to Source On Resistance	I _D = 80A,	T _J = 25 ^o C	-	0.85	1.1	mΩ
R _{DS(on)}		V _{GS} = 10V	$T_{J} = 175^{\circ}C$ (Note 4)	-	1.5	2.2	mΩ
Dynam	ic Characteristics						
C _{iss}	Input Capacitance			-	13650	-	pF
C _{oss}	Output Capacitance	− V _{DS} = 30V, V f = 1MHz	V _{GS} = 0V,	-	3375	-	pF
C _{rss}	Reverse Transfer Capacitance			-	255	-	pF
R _g	Gate Resistance	f = 1MHz		-	2.3	-	Ω
5	Total Cata Charge at 101/				470	000	
Q _{a(ToT)}	Total Gate Charge at 10V	V _{GS} = 0 to 1	0V Vpp = 48V	-	170	220	nC
Q _{g(ToT)} Q _{a(th)}	Threshold Gate Charge			-	24	32	nC
Q _{g(th)}		$V_{GS} = 0$ to 1 $V_{GS} = 0$ to 2		-	-	-	
$\frac{Q_{g(ToT)}}{Q_{g(th)}}$ $\frac{Q_{gs}}{Q_{gd}}$	Threshold Gate Charge			-	24	32	nC
Q _{g(th)} Q _{gs} Q _{gd}	Threshold Gate Charge Gate-to-Source Gate Charge			-	24 56	32	nC nC
Q _{g(th)} Q _{gs} Q _{gd} Switchi	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics			-	24 56	32 - -	nC nC nC
Q _{g(th)} Q _{gs} Q _{gd} Switchi	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time			-	24 56 24 -	32	nC nC nC nS
Q _{g(th)} Q _{gs} Q _{gd} Switchi t _{on}	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay	V _{GS} = 0 to 2	V I _D = 80A		24 56 24 - 45	32 - - 137	nC nC nC ns
Q _{g(th)} Q _{gs} Q _{gd} Switchi t _{on} t _{d(on)} t _r	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay Rise Time	V _{GS} = 0 to 2	V $I_D = 80A$	- - - -	24 56 24 - 45 61	32 - - 137 -	nC nC nC NS NS
$\begin{array}{c} Q_{g(th)} \\ Q_{gs} \\ Q_{gd} \\ \end{array}$ Switchi $\begin{array}{c} t_{on} \\ t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ \end{array}$	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay	V _{GS} = 0 to 2	V $I_D = 80A$	- - - - - - -	24 56 24 - 45	32 - - 137 - -	nC nC nC ns
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$\begin{array}{c} Q_{g(th)} \\ Q_{gs} \\ Q_{gd} \\ \hline \\ $	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time	V _{GS} = 0 to 2	V $I_D = 80A$	- - - - - - - - -	24 56 24 - 45 61 80 41	32 - - - - - - - - -	nC nC nC ns ns ns ns ns
$Q_{g(th)}$ Q_{gs} Q_{gd} Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f t_{off} Drain-S	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time ource Diode Characteristics	V _{GS} = 0 to 2	V $I_D = 80A$ $I_D = 80A$, $R_{GEN} = 6Ω$	- - - - - - - - -	24 56 24 - 45 61 80 41	32 - - 137 - - - - - 156	nC nC nS ns ns ns ns ns
$\begin{array}{c} Q_{g(th)} \\ Q_{gs} \\ Q_{gd} \\ \hline \\ $	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time	V _{GS} = 0 to 2	V $I_D = 80A$, R _{GEN} = 6Ω GS = 0V	- - - - - - - - -	24 56 24 - 45 61 80 41	32 - - 137 - - - 156 1.25	nC nC nC ns ns ns ns ns
$Q_{g(th)}$ Q_{gs} Q_{gd} Switchi t_{on} $t_{d(on)}$ t_r $t_{d(off)}$ t_f t_{off} Drain-S	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics Turn-On Time Turn-On Delay Rise Time Turn-Off Delay Fall Time Turn-Off Time ource Diode Characteristics	$V_{GS} = 0 \text{ to } 2$ $V_{DD} = 30V,$ $V_{GS} = 10V,$ $I_{SD} = 80A, V$ $I_{SD} = 40A, V$	V $I_D = 80A$, R _{GEN} = 6Ω GS = 0V	- - - - - - - - -	24 56 24 - 45 61 80 41 -	32 - - 137 - - - - - 156	nC nC nS ns ns ns ns vs V

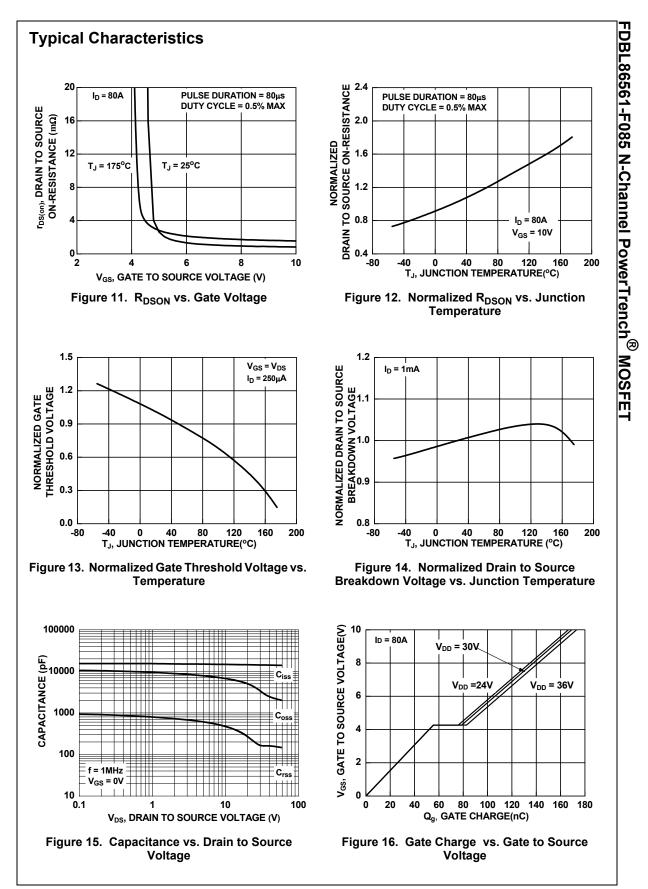
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